

CGB4B3X7R0J225M055AB

TDK Item Description : CGB4B3X7R0J225MT****



Application & Main Feature

Commercial Grade (Low Profile)

Series

CGB4(2012) [EIA CC0805]



Dimensions

L 2.00mm +/-0.2mm
 W 1.25mm +/-0.2mm
 T 0.55mm Max.
 B 0.20mm Min.
 G 0.50mm Min.

Temperature Characteristic

X7R (-55 to 125 degC +/-15%)

Rated Voltage

0J (6.3Vdc)

Capacitance

2.2uF

Capacitance Tolerance

M (+/-20%)

Dissipation Factor

10% Max.

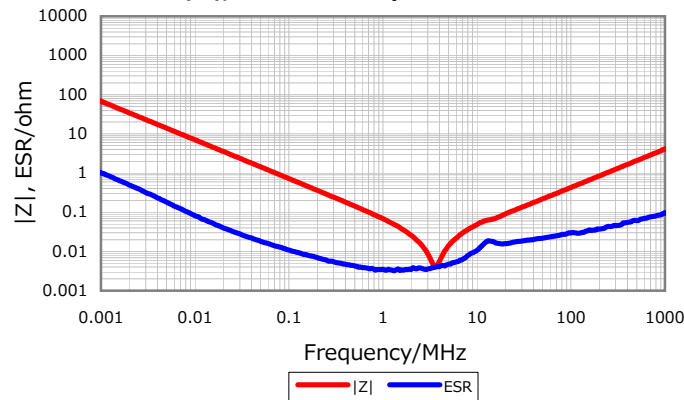
Insulation Resistance

45Mohm Min.

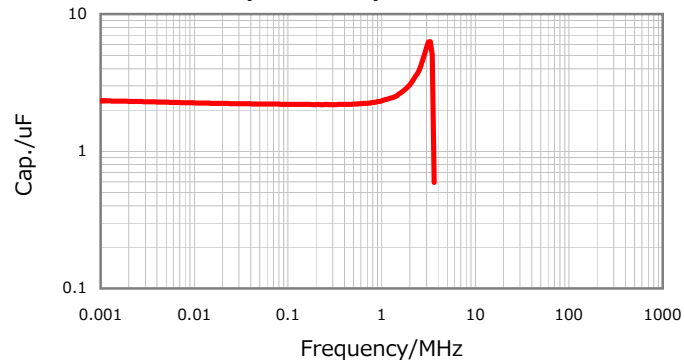
AEC-Q200

Not Applicable

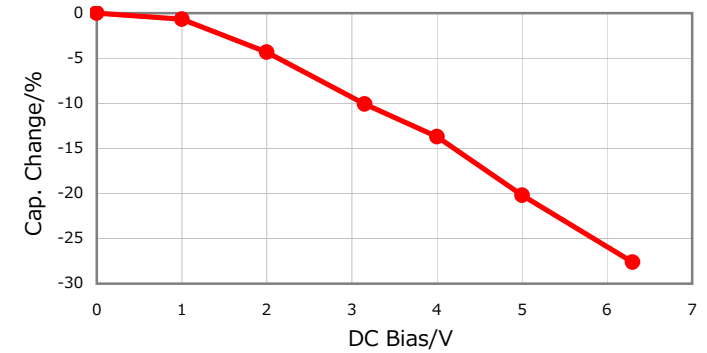
|Z|, ESR vs. Freq. Characteristics



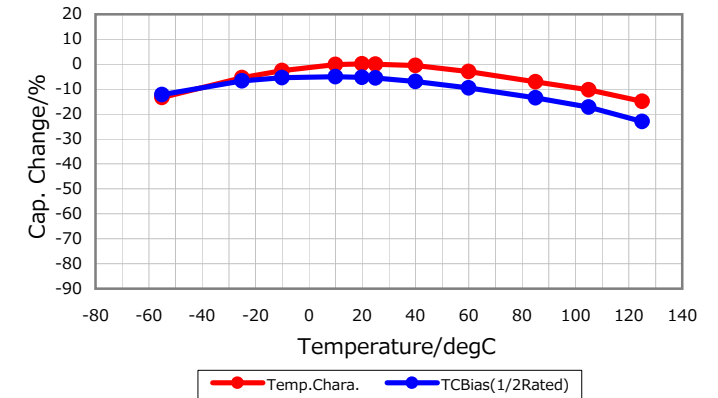
Cap. vs. Freq. Characteristic



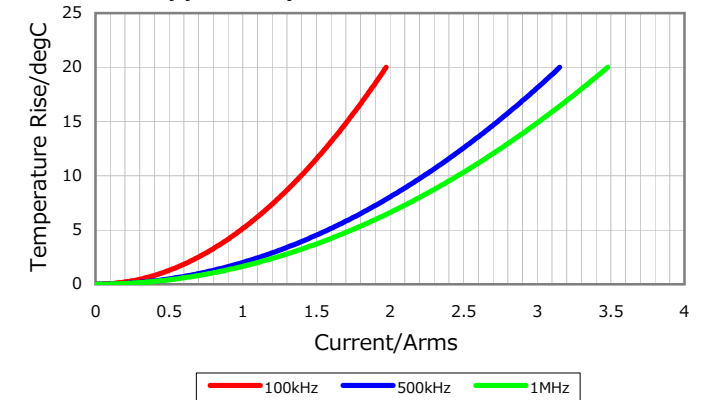
DC Bias Characteristic



Temperature Characteristics



Ripple Temperature Rise Characteristics



Characterization Sheet (Multilayer Ceramic Chip Capacitors)



All specifications are subject to change without notice.

January 4, 2016